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## **FACSIMILE COVER SHEET**

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NAME OF INVENTOR(S): Mahdavi  TITLE OF INVENTION:		Serial No.: 10/612,123 Filing Date: 7/2/2003
THIN FILM RESISTOR ET	CH DEPOSIT ACCT. NO.: 20-0868	
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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Mahdavi

Docket No:

TI-35198

Setial No:

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Examiner:

Deo, Duy Vu Nguyen SEP 1 2 2005

Filed:

7/2/2003

Art Unit:

1765

For:

THIN FILM RESISTOR ETCH

## **RESPONSE**

**Assistant Commissioner For Patents** Washington, DC 20231

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at 571-273-8300 on the date shown below:

Dear Sir:

Responsive to the Office Action mailed August 18, 2005, in connection with the above identified application, Applicant(s) respectfully submit(s) the following remarks.